

# 18V, 4A Synchronous Step-Down DC/DC Converter

### **Description**

The FR9207 is a synchronous step-down DC/DC converter. The device provides 4.5V to 18V input voltage range and 4A continuous load current capability. Operation frequency depends on Input and output voltage condition. At light load condition, the FR9207 can operate at power saving mode to support high efficiency and reduce power loss.

The FR9207 fault protection includes cycle-by-cycle current limit, short circuit protection, UVLO and thermal shutdown. The soft-start function prevents inrush current at turn-on. The FR9207 use fast constant on time control that provides fast transient response, the noise immunity and all kinds of very low ESR output capacitor for ensuring performance stabilization.

The FR9207 is offered in TSOT-23-6 package, which provides good thermal conductance.

# **Pin Assignments**

S9 Package: TSOT-23-6

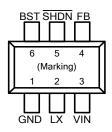


Figure 1. Pin Assignments of FR9207

#### **Features**

- Low R<sub>DS(ON)</sub> Integrated Power MOSFET (50mΩ/22mΩ)
- Wide Input Voltage Range: 4.5V to 18V
- Output Voltage Range: 0.76V to 8V
- 4A Output Current
- FCOT Mode Enables Fast Transient Response
- Pseudo 500kHz Frequency
- Support All Ceramic Capacitors
- Internal 1ms Soft-Start
- Output Discharge Function
- Input Under Voltage Lockout
- Cycle-by-Cycle Current Limit
- Hiccup Short Circuit Protection
- Over Temperature Protection with Auto Recovery
- TSOT-23-6 Package

### **Applications**

- STB (Set-Top-Box)
- LCD Display, TV
- Distributed Power System
- Networking, XDSL Modem
- Surveillance

# **Ordering Information**



#### **TSOT-23-6 Marking**

Part Number	Product Code	
FR9207S9	GC3	



# **Typical Application Circuit**

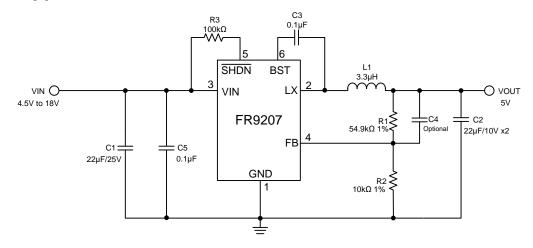


Figure 2. FR9207 Application Circuit

V<sub>IN</sub>=12V, the recommended BOM list is as below.

V <sub>OUT</sub>	C1	R1	R2	C4 (Note 1)	L1	C2
1.05V	22µF MLCC	3.74kΩ	10kΩ	82pF	2.2µH	22µF MLCC x2
1.2V	22µF MLCC	5.76kΩ	10kΩ	82pF	2.2µH	22µF MLCC x2
1.8V	22µF MLCC	13.7kΩ	10kΩ	82pF	2.2µH	22µF MLCC x2
2.5V	22µF MLCC	22.6kΩ	10kΩ	82pF	2.2µH	22µF MLCC x2
3.3V	22µF MLCC	33.2kΩ	10kΩ	82pF	2.2µH	22µF MLCC x2
5V	22µF MLCC	54.9kΩ	10kΩ	82pF	3.3µH	22µF MLCC x2

Table 1. Recommended Component Values

Note 1: It can be fine-tuned according to different application conditions, for example PCB layout, C2 and R1.

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# **Functional Pin Description**

Pin Name	Pin No.	Pin Function
GND	1	Ground pin.
LX	2	Power switching node. Connect an external inductor to this switching node.
VIN	3	Power supply input pin. Placed input capacitors as close as possible from VIN to GND to avoid noise influence.
FB	4	Voltage feedback input pin. Connect FB and VOUT with a resistive voltage divider. This IC senses feedback voltage via FB and regulates it at 0.760V±1%.
SHDN 5 self-startup.		Enable input pin. Pull high to turn on IC, and pull low to turn off IC. Connect VIN with a $100k\Omega$ resistor for self-startup.
		High side gate drive boost pin. A capacitor rating between 0.1uF~1uF must be connected from this pin to LX. It can boost the gate drive to fully turn on the internal high side NMOS.

# **Block Diagram**

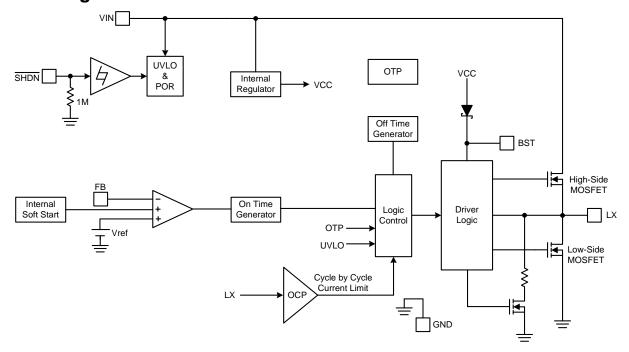


Figure 3. Block Diagram of FR9207



# Absolute Maximum Ratings (Note 2)

Supply Voltage V <sub>IN</sub>	0.3V to +20V
• Enable Voltage V <sub>SHDN</sub>	-0.3V to +20V
• LX Voltage V <sub>LX</sub>	-0.3V to V <sub>IN</sub> +0.3V
Dynamic LX Voltage in 15nS Duration	5V to V <sub>IN</sub> +5V
BST Pin Voltage V <sub>BST</sub>	-0.3V to $V_{LX}$ +6.5V
All Other Pins Voltage	-0.3V to +6V
Maximum Junction Temperature (T <sub>J</sub> )	+150°C
Storage Temperature (T <sub>S</sub> )	-65°C to +150°C
• Lead Temperature (Soldering, 10sec.)	+260°C
<ul> <li>Package Thermal Resistance, (θ<sub>JA</sub>) (Note 3)</li> </ul>	
TSOT-23-6	85°C/W
<ul> <li>Package Thermal Resistance, (θ<sub>JC</sub>)</li> </ul>	
TSOT-23-6	20°C/W

Note 2: Stresses beyond this listed under "Absolute Maximum Ratings" may cause permanent damage to the device. Note 3:  $\theta_{JA}$  is measured at 25°C ambient with the component mounted on a high effective thermal conductivity 4-layer board of JEDEC-51-7. The thermal resistance greatly varies with layout, copper thickness, number of layers and PCB size.

# **Recommended Operating Conditions**

Supply Voltage V <sub>IN</sub>	+4.5V to +18V
Operating Ambient Temperature Range	
Operating Junction Temperature Range	

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# **Electrical Characteristics**

(V<sub>IN</sub>=12V, T<sub>A</sub>=25°C, unless otherwise specified.)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
V <sub>IN</sub> Quiescent Current	I <sub>DDQ</sub>	V <sub>SHDN</sub> =2V, V <sub>FB</sub> =1V		0.4		mA
V <sub>IN</sub> Shutdown Supply Current	I <sub>SD</sub>	V <sub>SHDN</sub> =0V		3	10	μA
Feedback Threshold Voltage	$V_{FB}$	4.5V≦V <sub>IN</sub> ≦18V, In PWM Mode	753	760	767	mV
Feedback Input Current	I <sub>FB</sub>	V <sub>FB</sub> =1V		0.01	0.1	μA
High-Side MOSFET R <sub>DS(ON)</sub>	R <sub>DS(ON)</sub>			50		mΩ
Low-Side MOSFET R <sub>DS(ON)</sub>	R <sub>DS(ON)</sub>			22		mΩ
Valley Current Limit (Note 4)	I <sub>LIMIT</sub>		4.2	6.2	8	Α
On Time	T <sub>ON</sub>	V <sub>IN</sub> =12V, V <sub>OUT</sub> =1.05V, PSM, No load		120		ns
Minimum On Time	T <sub>ON(MIN)</sub>			40		ns
Minimum Off Time	T <sub>OFF(MIN)</sub>			200		ns
Input Supply Voltage UVLO Threshold	V <sub>UVLO(Vth)</sub>	V <sub>IN</sub> Rising		4	4.3	V
UVLO Threshold Hysteresis	V <sub>UVLO(HYS)</sub>			0.35		V
Internal Soft-Start Period (Note 4)	T <sub>SS</sub>			1		ms
SHDN Input Low Voltage	V <sub>SHDN(L)</sub>				0.8	٧
SHDN Input High Voltage	V <sub>SHDN(H)</sub>		1.6			٧
SHDN Input Current	ISHDN	V <sub>SHDN</sub> =2V		2		μA
Output Discharge Resistance (Note 4)	R <sub>DIS</sub>			60		Ω
Output Under Voltage Trip Threshold				30		%
Output Under Voltage Trip Threshold Hysteresis				10		%
Thermal Shutdown Threshold (Note 4)	T <sub>SD</sub>			160		°C
Thermal Shutdown Hysteresis (Note 4)	T <sub>HYS</sub>			30		°C

Note 4: Not production tested.

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# **Typical Performance Curves**

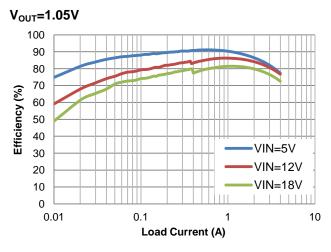


Figure 4. Efficiency vs. Load Current

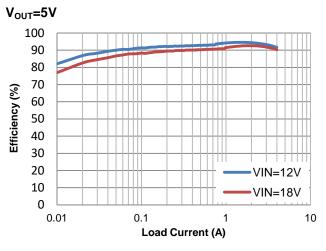


Figure 6. Efficiency vs. Load Current

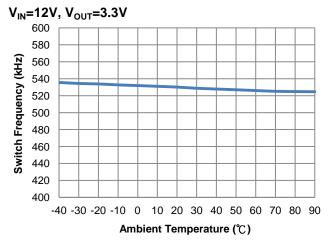


Figure 8. Switch Frequency vs. Ambient Temperature

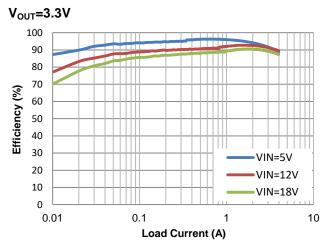


Figure 5. Efficiency vs. Load Current

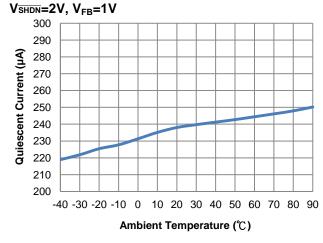


Figure 7. Quiescent Current vs. Ambient Temperature

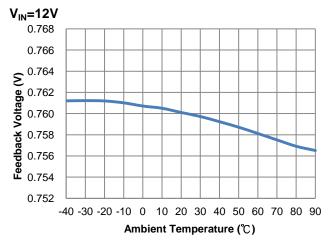


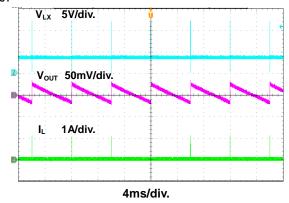
Figure 9. Feedback Voltage vs. Ambient Temperature



# **Typical Performance Curves (Continued)**

 $V_{IN}=12V$ ,  $V_{OUT}=3.3V$ ,  $C1=22\mu F$ ,  $C2=22\mu F^*2$ , C4=82pF,  $L1=2.2\mu H$ ,  $T_A=+25^{\circ}C$ , unless otherwise noted.





 $I_{OUT}=4A$ 

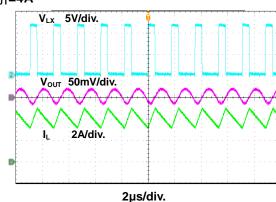
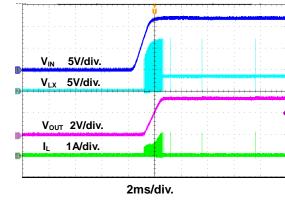


Figure 10. Steady State Waveform

Figure 11. Steady State Waveform





 $I_{OUT}=4A$ 

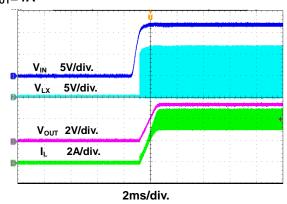
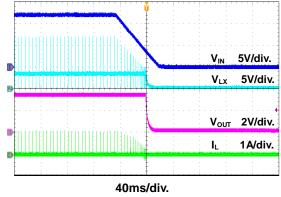


Figure 12. Startup Through Power Supply Waveform







 $I_{OUT}=4A$ 

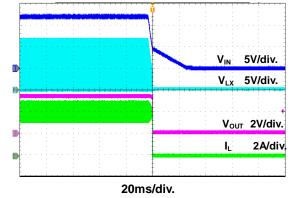


Figure 14. Shutdown Through Power Supply Waveform

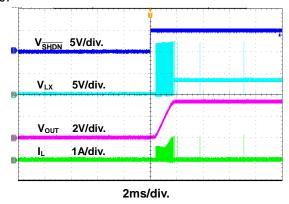
Figure 15. Shutdown Through Power Supply Waveform



# **Typical Performance Curves (Continued)**

 $V_{IN}=12V$ ,  $V_{OUT}=3.3V$ ,  $C1=22\mu F$ ,  $C2=22\mu F^*2$ , C4=82pF,  $L1=2.2\mu H$ ,  $T_A=+25^{\circ}C$ , unless otherwise noted.





I<sub>OUT</sub>=4A

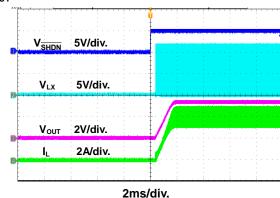
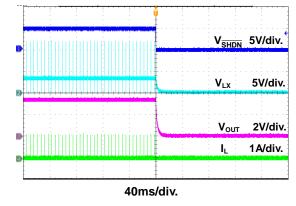


Figure 16. Startup Through SHDN Waveform

Figure 17. Startup Through SHDN Waveform





 $I_{OUT}=4A$ 

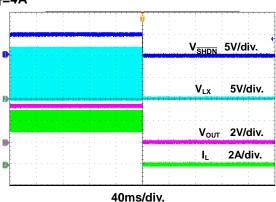
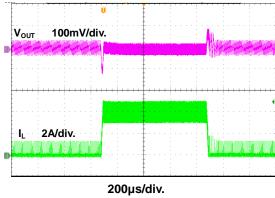


Figure 18. Shutdown Through SHDN Waveform

Figure 19. Shutdown Through SHDN Waveform

### I<sub>OUT</sub>=0.1A to 4A



I<sub>OUT</sub>=2A to 4A

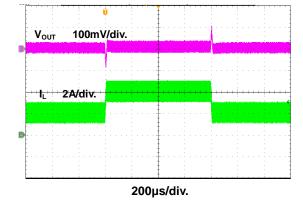


Figure 20. Load Transient Waveform

Figure 21. Load Transient Waveform



### **Function Description**

The FR9207 is a synchronous step-down DC/DC converter with fast constant on time (FCOT) mode control. It has integrated high-side ( $50m\Omega$ , typ) and low-side ( $22m\Omega$ , typ) power switches, and provides 5A continuous load current. It regulates input voltage from 4.5V to 18V, and down to an output voltage as low as 0.76V. Using FCOT control scheme provides fast transient response, which can minimize the component size without additional external compensation network.

#### **Enable**

The FR9207  $\overline{\text{SHDN}}$  pin provides digital control to turn on/turn off the regulator. When the voltage of  $\overline{\text{SHDN}}$  exceeds the threshold voltage, the regulator starts the soft start function. If the  $\overline{\text{SHDN}}$  pin voltage is below than the shutdown threshold voltage, the regulator will turn into the shutdown mode and the shutdown current will be smaller than 1µA. For auto start-up operation, connect  $\overline{\text{SHDN}}$  to VIN through a 100k $\Omega$  resistor.

#### Soft Start

The FR9207 employs internal soft start function to reduce input inrush current during start up. The typical value of internal soft start time is 1.0ms.

#### **Input Under Voltage Lockout**

When the FR9207 is power on, the internal circuits are held inactive until  $V_{\text{IN}}$  voltage exceeds the input UVLO threshold voltage. And the regulator will be disabled when  $V_{\text{IN}}$  is below the input UVLO threshold voltage. The hysteretic of the UVLO comparator is 350mV (typ).

#### **Over Current Protection**

The FR9207 over current protection function is implemented using cycle-by-cycle current limit architecture. The inductor current is monitored by Low-side MOSFET. When the load current increases, the inductor current also increases. When the valley inductor current reaches the current limit threshold, the output voltage starts to drop. When the over current condition is removed, the output voltage returns to the regulated value.

#### **Short Circuit Protection**

The FR9207 provides short circuit protection function to prevent the device damage from short condition. When the short condition occurs and the feedback voltage drops lower than 0.35V, the oscillator frequency will be reduced naturally and hiccup mode will be triggered to prevent the inductor current increasing beyond the current limit. Once the short condition is removed, the frequency will return to normal.

#### **Over Temperature Protection**

The FR9207 incorporates an over temperature protection circuit to protect itself from overheating. When the junction temperature exceeds the thermal shutdown threshold temperature, the regulator will be shutdown. And the hysteretic of the over temperature protection is 30°C (typ).



### **Application Information**

#### **Output Voltage Setting**

The output voltage  $V_{\text{OUT}}$  is set using a resistive divider from the output to FB. The FB pin regulated voltage is 0.76V. Thus the output voltage equation is:

$$V_{OUT} = 0.76V \times \left(1 + \frac{R1}{R2}\right)$$

Table 2 lists recommended values of R1 and R2 for most used output voltage.

Table 2 Recommended Resistance Values

V <sub>out</sub>	R1	R2
5V	54.9kΩ	10kΩ
3.3V	33.2kΩ	10kΩ
2.5V	22.6kΩ	10kΩ
1.8V	13.7kΩ	10kΩ
1.2V	5.76kΩ	10kΩ
1.05V	3.74kΩ	10kΩ

Place resistors R1 and R2 close to FB pin to prevent stray pickup.

#### **Input Capacitor Selection**

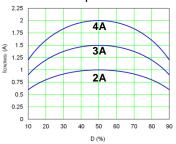
The use of the input capacitor is filtering the input voltage ripple and the MOSFETS switching spike voltage. Because the input current to the step-down converter is discontinuous, the input capacitor is required to supply the current to the converter to keep the DC input voltage. The capacitor voltage rating should be 1.25 to 1.5 times greater than the maximum input voltage. The input capacitor ripple current RMS value is calculated as:

$$I_{CIN(RMS)} = I_{OUT} \times \sqrt{D \times (1-D)}$$

$$D = \frac{V_{OUT}}{V_{IN}}$$

Where D is the duty cycle of the power MOSFET.

This function reaches the maximum value at D=0.5 and the equivalent RMS current is equal to  $I_{OUT}/2$ . The following diagram is the graphical representation of above equation.



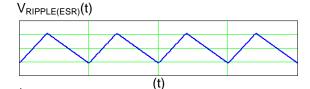
A low ESR capacitor is required to keep the noise minimum. Ceramic capacitors are better, but tantalum or low ESR electrolytic capacitors may also suffice. When using tantalum or electrolytic capacitors, a  $0.1\mu F$  ceramic capacitor should be placed as close to the IC as possible.

#### **Output Capacitor Selection**

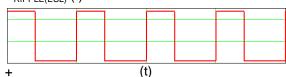
The output capacitor is used to keep the DC output voltage and supply the load transient current. When operating in constant current mode, the output ripple is determined by four components:

$$\begin{aligned} V_{\text{RIPPLE}}(t) = & V_{\text{RIPPLE}(C)}(t) + V_{\text{RIPPLE}(ESR)}(t) \\ & + V_{\text{RIPPLE}(ESL)}(t) + V_{\text{NOISE}}(t) \end{aligned}$$

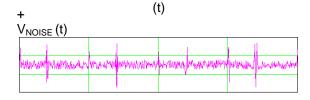
The following figures show the form of the ripple contributions.

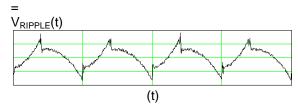


V<sub>RIPPLE(ESL)</sub> (t)



V<sub>RIPPLE(C)</sub> (t)







### **Application Information (Continued)**

$$V_{RIPPLE(ESR)} = \frac{V_{OUT}}{F_{OSC} \times L} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right) \times ESR$$

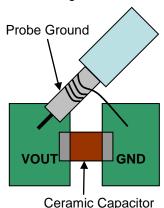
$$V_{RIPPLE(ESL)} = \frac{ESL}{L} \times V_{IN}$$

$$V_{RIPPLE(C)} = \frac{V_{OUT}}{8 \times F_{OSC^2} \times L \times C_{OUT}} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right)$$

Where  $F_{OSC}$  is the switching frequency, L is the inductance value,  $V_{IN}$  is the input voltage, ESR is the equivalent series resistance value of the output capacitor, ESL is the equivalent series inductance value of the output capacitor and the  $C_{OUT}$  is the output capacitor.

Low ESR capacitors are preferred to use. Ceramic, tantalum or low ESR electrolytic capacitors can be used depending on the output ripple requirement. When using the ceramic capacitors, the ESL component is usually negligible.

It is important to use the proper method to eliminate high frequency noise when measuring the output ripple. The figure shows how to locate the probe across the capacitor when measuring output ripple. Removing the scope probe plastic jacket in order to expose the ground at the tip of the probe. It gives a very short connection from the probe ground to the capacitor and eliminating noise.



#### **Inductor Selection**

The output inductor is used for storing energy and filtering output ripple current. But the trade-off condition often happens between maximum energy storage and the physical size of the inductor. The first consideration for selecting the output inductor is to make sure that the inductance is large enough to keep the converter in the continuous current mode.

That will lower ripple current and result in lower output ripple voltage. The  $\Delta I_L$  is inductor peak-to-peak ripple current:

$$\Delta I_{L} = \frac{V_{OUT}}{F_{OSC} \times L} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right)$$

A good compromise value between size and efficiency is to set the peak-to-peak inductor ripple current  $\Delta I_L$  equal to 30% of the maximum load current. But setting the peak-to-peak inductor ripple current  $\Delta I_L$  between 20%~50% of the maximum load current is also acceptable. Then the inductance can be calculated with the following equation:

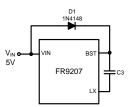
$$\Delta I_L = 0.3 \times I_{OUT(MAX)}$$

$$L = \frac{(V_{IN} - V_{OUT}) \times V_{OUT}}{V_{IN} \times F_{OSC} \times \Delta I_{L}}$$

To guarantee the required output current, the inductor needs a saturation current rating and a thermal rating that exceeds IL (peak current). These are minimum requirements. To maintain control of inductor current in overload and short circuit conditions, some applications may desire current ratings up to the current limit value.

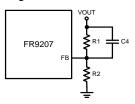
#### **External Diode Selection**

For 5V input applications, it is recommended to add an external boost diode. This helps improving the efficiency. The boost diode can be a low cost one such as 1N4148.



#### **Feedforward Capacitor Selection**

Internal compensation function allows users saving time in design and saving cost by reducing the number of external components. The use of a feedforward capacitor C4 in the feedback network is recommended to improve the transient response or higher phase margin.





## **Application Information (Continued)**

For optimizing the feedforward capacitor, knowing the cross frequency is the first thing. The cross frequency (or the converter bandwidth) can be determined by using a network analyzer. When getting the cross frequency with no feedforward capacitor identified, the value of feedforward capacitor C4 can be calculated with the following equation:

$$C4 = \frac{1}{2\pi \times F_{CROSS}} \times \sqrt{\frac{1}{R1} \times \left(\frac{1}{R1} + \frac{1}{R2}\right)}$$

Where F<sub>CROSS</sub> is the cross frequency.

To reduce transient ripple, the feedforward capacitor value can be increased to push the cross frequency to higher region. Although this can improve transient response, it also decrease phase margin and cause more ringing. In the other hand, if more phase margin is desired, the feedforward capacitor value can be decreased to push the cross frequency to lower region. For the FR9207 applications, a 82pF feedforward capacitor is recommended.

#### **PCB Layout Recommendation**

The device's performance and stability is dramatically affected by PCB layout. It is recommended to follow these general guidelines shown as below:

- Place the input capacitors and output capacitors as close to the device as possible. Trace to these capacitors should be as short and wide as possible to minimize parasitic inductance and resistance.
- 2. Place feedback resistors close to the FB pin.
- 3. Keep the sensitive signal (FB) away from the switching signal (LX).
- 4. Multi-layer PCB design is recommended.

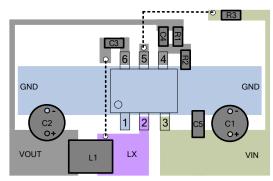
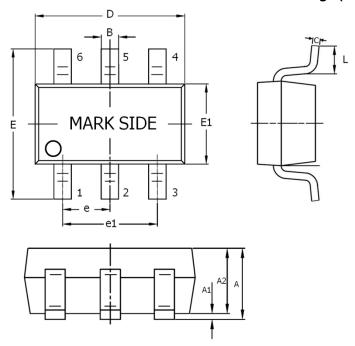


Figure 22. Recommended PCB Layout Diagram



### **Outline Information**

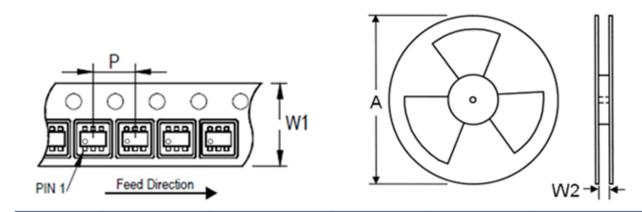
#### TSOT-23-6 Package (Unit: mm)



SYMBOLS	DIMENSION IN MILLIMETER			
UNIT	MIN	MAX		
Α	0.70	0.95		
A1	0.00	0.10		
A2	0.70	0.85		
В	0.30	0.50		
D	2.80	3.00		
E	2.60	3.00		
E1	1.50	1.70		
е	0.90	1.00		
e1	1.80	2.00		
С	0.08	0.20		
L	0.30	0.60		

Note 5: Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.3mm.

### **Carrier Dimensions**



Tape Size	Pocket Pitch	Reel Size (A)		Reel Width	Empty Cavity	Units per Reel
(W1) mm	(P) mm	in	mm	(W2) mm	Length mm	
8	4	7	180	8.4	300~1000	3,000

**Life Support Policy**Fitipower's products are not authorized for use as critical components in life support devices or other medical systems.

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